INITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Emami, et al.

Serial No.:

09/727,133

Confirmation No.:

2919

Filed: November 29, 2000

Planarized Copper Cleaning for

Reduced Defects

 Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Group Art Unit: 1763

Examiner: George A. Goudreau

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on October 31, 2003, with the United States Postal Service as First Class Mail in an envelope addressed to: MAIL STOP NON-FEE AMENDMENT Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature

RESPONSE TO OFFICE ACTION DATED AUGUST 1, 2003

In response to the Office Action dated August 1, 2003, having a shortened statutory period for response set to expire on November 1, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/3976.P1/KMT, for any fees, including extension of time fees in excess of the petition above, or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. Remarks/Arguments begin on page 11 of this paper.